

L Number	Hits	Search Text	DB	Time stamp
1	80380	340/\$.ccls.	USPAT	2004/01/07 13:56
2	2591	tamper adj1 resistant	USPAT	2004/01/07 13:56
3	188	340/\$.ccls. and (tamper adj1 resistant)	USPAT	2004/01/07 14:00
4	100	235/\$.ccls. and tamper adj1 resistant	USPAT	2004/01/07 14:03
5	2776	713/184.ccls. or 713/185.ccls. or 713/189.ccls. or 713/192.ccls. or 713/194.ccls. or 713/200-202.ccls.	USPAT	2004/01/07 14:05
6	579	705/41-44.ccls.	USPAT	2004/01/07 14:05
7	218	705/64-65.ccls.	USPAT	2004/01/07 14:05
8	331	340/687.ccls.	USPAT	2004/01/07 14:06
9	80380	340/\$.ccls.	USPAT	2004/01/07 14:06
10	4703	235/492.ccls. or 235/380.ccls. or 235/487.ccls. or 235/435.ccls. or 235/462.25	USPAT	2004/01/07 14:07
11	87579	(235/\$.ccls. and tamper adj1 resistant) or (713/184.ccls. or 713/185.ccls. or 713/189.ccls. or 713/192.ccls. or 713/194.ccls. or 713/200-202.ccls.) or 705/41-44.ccls. or 705/64-65.ccls. or 340/687.ccls. or 340/\$.ccls. or (235/492.ccls. or 235/380.ccls. or 235/487.ccls. or 235/435.ccls. or 235/462.25)	USPAT	2004/01/07 14:07
12	11758	encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3	USPAT; EPO; JPO	2004/01/07 14:08
13	859	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (display\$4 and pad)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
14	9	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad) same touch near2 screen	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
15	4416	chip near2 glass	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
16	8	(touch near2 pad) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
17	37	(touch near2 screen and tamper adj1 resistant) and (PIN or key or password)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
18	29	COG and ASIC	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
19	39	wire near2 technology near4 pad	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
20	230	ASIC same (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:15
21	82	(four adj2 wire)and (touch adj1 pad or touch adj1 screen)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:13
22	199	380/227-229.ccls.	USPAT	2004/01/07 14:13
23	329	380/227-229.ccls. or 380/239.ccls.	USPAT	2004/01/07 14:14
24	10139	touch adj2 screen	USPAT	2004/01/07 14:15
25	3	(touch adj2 screen) and (COG and ASIC)	USPAT	2004/01/07 14:15

26	7	silicon near2 circuit and tamper adj2 resistant	USPAT	2004/01/07 14:18
-	1	("5475377").PN.	USPAT	2004/01/06 11:09
-	7590	encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3	USPAT	2004/01/07 14:08
-	43789	display\$4 and pad	USPAT	2004/01/06 11:11
-	850	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (display\$4 and pad)	USPAT	2004/01/07 14:08
-	194	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad	USPAT	2004/01/06 11:14
-	7	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad) same touch near2 screen	USPAT	2004/01/07 14:08
-	3836	touch near2 pad	USPAT	2004/01/06 11:20
-	1183	(encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit	USPAT	2004/01/06 11:21
-	6	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)) and (touch near2 pad)	USPAT	2004/01/06 11:24
-	7	(touch near2 pad) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/07 14:09
-	95	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (touch near2 pad)	USPAT	2004/01/06 11:26
-	6	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (touch near2 pad)) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/06 11:26
-	813	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/06 12:37
-	675	tamper near2 detect\$4	USPAT	2004/01/06 12:51
-	0	n adj1 wire adj1 technology	USPAT	2004/01/06 13:28
-	0	"4" adj1 wire adj1 technology	USPAT	2004/01/06 13:29
-	3	four adj1 wire adj1 technology	USPAT	2004/01/06 13:29
-	0	wire adj1 technology adj1 pad	USPAT	2004/01/06 13:36
-	91	touch adj1 pad same wire	USPAT	2004/01/06 13:39
-	9174	four adj2 wire	USPAT	2004/01/06 13:39
-	2634	touch adj1 pad	USPAT	2004/01/06 13:40
-	0	(four adj2 wire) same (touch adj1 pad)	USPAT	2004/01/06 13:42
-	634	touch near2 screen and ASIC	USPAT	2004/01/06 13:42
-	2634	touch adj1 pad	USPAT	2004/01/06 13:43
-	54	(touch near2 screen and ASIC) and (touch adj1 pad)	USPAT	2004/01/06 13:45
-	0	chip adj1 on adj1 glass	USPAT	2004/01/06 13:48
-	1147	chip adj1 glass	USPAT	2004/01/06 13:46
-	0	(chip adj1 glass) and ((touch near2 screen and ASIC) and (touch adj1 pad))	USPAT	2004/01/06 13:46

-	0	(chip adj1 glass) and (touch near2 screen and ASIC)	USPAT	2004/01/06 13:46
-	0	(chip adj1 glass) and (touch adj1 pad)	USPAT	2004/01/06 13:46
-	2992	chip near2 glass	USPAT	2004/01/07 14:08
-	0	(chip near2 glass) and ((touch near2 screen and ASIC) and (touch adj1 pad))	USPAT	2004/01/06 13:46
-	0	(chip near2 glass) and (touch adj1 pad)	USPAT	2004/01/06 13:46
-	0	(chip near2 glass) and (touch near2 screen and ASIC)	USPAT	2004/01/06 13:48
-	0	chip near1 on near1 glass	USPAT	2004/01/06 13:48
-	0	chip near2 glass and (touch adj1 pad)	USPAT	2004/01/06 13:54
-	23	COG near2 technology	USPAT	2004/01/07 07:42
-	0	COG and temper near2 resistant	USPAT	2004/01/06 15:18
-	4	COG and temper near2 resistant	USPAT	2004/01/06 15:18
-	0	touch near2 screen and ASIX and tamper adj1 resistant	USPAT	2004/01/07 07:42
-	1	touch near2 screen and ASIC and tamper adj1 resistant	USPAT	2004/01/07 07:43
-	43	touch near2 screen and tamper adj1 resistant	USPAT	2004/01/07 07:43
-	783961	PIN or key or password	USPAT	2004/01/07 07:43
-	36	(touch near2 screen and tamper adj1 resistant) and (PIN or key or password)	USPAT	2004/01/07 14:09
-	29	COG and ASIC	USPAT	2004/01/07 14:09
-	17447	encrypt\$4 or cipher\$4 or encipher\$4	USPAT	2004/01/07 14:04
-	1118	ASIC and (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT	2004/01/07 10:01
-	218	ASIC same (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT	2004/01/07 14:10
-	826	(encrypt\$4 or cipher\$4 or encipher\$4)near2 circuit	USPAT	2004/01/07 10:02
-	83	((encrypt\$4 or cipher\$4 or encipher\$4)near2 circuit) and ASIC	USPAT	2004/01/07 10:24
-	37	wire near2 technology near4 pad	USPAT	2004/01/07 14:09
-	3848	(n near2wire near2 technology) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:31
-	5733	(four near2wire near2 technology) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 14:18
-	0	(four adj2 wire adj3 technology)and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:49
-	77	(four adj2 wire)and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 14:10
-	0	(four adj2 wire)and (seven adj2 wire) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:52
-	1	(seven adj2 wire) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:52

L Number	Hits	Search Text	DB	Time stamp
1	80380	340/\$.ccls.	USPAT	2004/01/07 13:56
2	2591	tamper adj1 resistant	USPAT	2004/01/07 13:56
3	188	340/\$.ccls. and (tamper adj1 resistant)	USPAT	2004/01/07 14:00
4	100	235/\$.ccls. and tamper adj1 resistant	USPAT	2004/01/07 14:03
5	2776	713/184.ccls. or 713/185.ccls. or 713/189.ccls. or 713/192.ccls. or 713/194.ccls. or 713/200-202.ccls.	USPAT	2004/01/07 14:05
6	579	705/41-44.ccls.	USPAT	2004/01/07 14:05
7	218	705/64-65.ccls.	USPAT	2004/01/07 14:05
8	331	340/687.ccls.	USPAT	2004/01/07 14:06
9	80380	340/\$.ccls.	USPAT	2004/01/07 14:06
10	4703	235/492.ccls. or 235/380.ccls. or 235/487.ccls. or 235/435.ccls. or 235/462.25	USPAT	2004/01/07 14:07
11	87579	(235/\$.ccls. and tamper adj1 resistant) or (713/184.ccls. or 713/185.ccls. or 713/189.ccls. or 713/192.ccls. or 713/194.ccls. or 713/200-202.ccls.) or 705/41-44.ccls. or 705/64-65.ccls. or 340/687.ccls. or 340/\$.ccls. or (235/492.ccls. or 235/380.ccls. or 235/487.ccls. or 235/435.ccls. or 235/462.25)	USPAT	2004/01/07 14:07
12	11758	encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3	USPAT; EPO; JPO	2004/01/07 14:08
13	859	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (display\$4 and pad)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
14	9	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad) same touch near2 screen	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
15	4416	chip near2 glass	USPAT; EPO; JPO; DERWENT	2004/01/07 14:08
16	8	(touch near2 pad) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
17	37	(touch near2 screen and tamper adj1 resistant) and (PIN or key or password)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
18	29	COG and ASIC	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
19	39	wire near2 technology near4 pad	USPAT; EPO; JPO; DERWENT	2004/01/07 14:09
20	230	ASIC same (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:10
21	82	(four adj2 wire)and (touch adj1 pad or touch adj1 screen)	USPAT; EPO; JPO; DERWENT	2004/01/07 14:10
-	1	("5475377").PN.	USPAT	2004/01/06 11:09
-	7590	encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3	USPAT	2004/01/07 14:08
-	43789	display\$4 and pad	USPAT	2004/01/06 11:11
-	850	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (display\$4 and pad)	USPAT	2004/01/07 14:08

-	194	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad	USPAT	2004/01/06 11:14
-	7	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) same pad) same touch near2 screen	USPAT	2004/01/07 14:08
-	3836	touch near2 pad	USPAT	2004/01/06 11:20
-	1183	(encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit	USPAT	2004/01/06 11:21
-	6	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)) and (touch near2 pad)	USPAT	2004/01/06 11:24
-	7	(touch near2 pad) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/07 14:09
-	95	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (touch near2 pad)	USPAT	2004/01/06 11:26
-	6	((encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and (touch near2 pad)) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/06 11:26
-	813	(encrypt\$4 or cipher\$4 or encipher\$4)near4(key or PIN or password\$3) and ((encrypt\$4 or cipher\$4 or encipher\$4)near4 circuit)	USPAT	2004/01/06 12:37
-	675	tamper near2 detect\$4	USPAT	2004/01/06 12:51
-	0	n adj1 wire adj1 technology	USPAT	2004/01/06 13:28
-	0	"4" adj1 wire adj1 technology	USPAT	2004/01/06 13:29
-	3	four adj1 wire adj1 technology	USPAT	2004/01/06 13:29
-	0	wire adj1 technology adj1 pad	USPAT	2004/01/06 13:36
-	91	touch adj1 pad same wire	USPAT	2004/01/06 13:39
-	9174	four adj2 wire	USPAT	2004/01/06 13:39
-	2634	touch adj1 pad	USPAT	2004/01/06 13:40
-	0	(four adj2 wire) same (touch adj1 pad)	USPAT	2004/01/06 13:42
-	634	touch near2 screen and ASIC	USPAT	2004/01/06 13:42
-	2634	touch adj1 pad	USPAT	2004/01/06 13:43
-	54	(touch near2 screen and ASIC) and (touch adj1 pad)	USPAT	2004/01/06 13:45
-	0	chip adj1 on adj1 glass	USPAT	2004/01/06 13:48
-	1147	chip adj1 glass	USPAT	2004/01/06 13:46
-	0	(chip adj1 glass) and ((touch near2 screen and ASIC) and (touch adj1 pad))	USPAT	2004/01/06 13:46
-	0	(chip adj1 glass) and (touch near2 screen and ASIC)	USPAT	2004/01/06 13:46
-	0	(chip adj1 glass) and (touch adj1 pad)	USPAT	2004/01/06 13:46
-	2992	chip near2 glass	USPAT	2004/01/07 14:08
-	0	(chip near2 glass) and ((touch near2 screen and ASIC) and (touch adj1 pad))	USPAT	2004/01/06 13:46
-	0	(chip near2 glass) and (touch adj1 pad)	USPAT	2004/01/06 13:46
-	0	(chip near2 glass) and (touch near2 screen and ASIC)	USPAT	2004/01/06 13:48

-	0	chip near1 on near1 glass	USPAT	2004/01/06 13:48
-	0	chip near2 glass and (touch adj1 pad)	USPAT	2004/01/06 13:54
-	23	COG near2 technology	USPAT	2004/01/07 07:42
-	0	COG and temper near2 resistant	USPAT	2004/01/06 15:18
-	4	COG and tamper near2 resistant	USPAT	2004/01/06 15:18
-	0	touch near2 screen and ASIX and tamper adj1 resistant	USPAT	2004/01/07 07:42
-	1	touch near2 screen and ASIC and tamper adj1 resistant	USPAT	2004/01/07 07:43
-	43	touch near2 screen and tamper adj1 resistant	USPAT	2004/01/07 07:43
-	783961	PIN or key or password	USPAT	2004/01/07 07:43
-	36	(touch near2 screen and tamper adj1 resistant) and (PIN or key or password)	USPAT	2004/01/07 14:09
-	29	COG and ASIC	USPAT	2004/01/07 14:09
-	17447	encrypt\$4 or cipher\$4 or encipher\$4	USPAT	2004/01/07 14:04
-	1118	ASIC and (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT	2004/01/07 10:01
-	218	ASIC same (encrypt\$4 or cipher\$4 or encipher\$4)	USPAT	2004/01/07 14:10
-	826	(encrypt\$4 or cipher\$4 or encipher\$4)near2 circuit	USPAT	2004/01/07 10:02
-	83	((encrypt\$4 or cipher\$4 or encipher\$4)near2 circuit) and ASIC	USPAT	2004/01/07 10:24
-	37	wire near2 technology near4 pad	USPAT	2004/01/07 14:09
-	3848	(n near2wire near2 technology) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:31
-	5733	(four near2wire near2 technology) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:48
-	0	(four adj2 wire adj3 technology)and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:49
-	77	(four adj2 wire)and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 14:10
-	0	(four adj2 wire)and (seven adj2 wire) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:52
-	1	(seven adj2 wire) and (touch adj1 pad or touch adj1 screen)	USPAT	2004/01/07 10:52

Status: Path 1 of [Dialog Information Services via Modem]

Status: Initializing TCP/IP using (UseTelnetProto 1 ServiceID dialog.com)
Trying 31060000009999...Open

DIALOG INFORMATION SERVICES

PLEASE LOGON:

***** HHHHHHHH SSSSSSSS?

Status: Signing onto Dialog

ENTER PASSWORD:

***** HHHHHHHH SSSSSSSS? *****

Welcome to DIALOG

Status: Connected

Dialog level 03.06.02D

Last logoff: 20dec03 08:59:28

Logon file405 07jan04 14:23:46

*** ANNOUNCEMENT ***

--File 654 - US published applications from March 15, 2001 to the present are now online. Please see HELP NEWS 654 for details.

--File 581 - The 2003 annual reload of Population Demographics is complete. Please see Help News581 for details.

--File 990 - NewsRoom now contains February 2003 to current records.
File 992 - NewsRoom 2003 archive has been newly created and contains records from January 2003. The oldest months's records roll out of File 990 and into File 992 on the first weekend of each month.
To search all 2003 records BEGIN 990, 992, or B NEWS2003, a new OneSearch category.

--Connect Time joins DialUnits as pricing options on Dialog.
See HELP CONNECT for information.

--SourceOne patents are now delivered to your email inbox as PDF replacing TIFF delivery. See HELP SOURCE1 for more information.

--Important news for public and academic libraries. See HELP LIBRARY for more information.

--Important Notice to Freelance Authors--
See HELP FREELANCE for more information

NEW FILES RELEASED

***DIOGENES: Adverse Drug Events Database (File 181)

***Emergency Room (File 454), Hospital Inpatient Profiles (File 462),
and Hospital Outpatient Profiles (File 463)

***World News Connection (File 985)

***Dialog NewsRoom - 2003 Archive (File 992)

***TRADEMARKSCAN-Czech Republic (File 680)

***TRADEMARKSCAN-Hungary (File 681)

***TRADEMARKSCAN-Poland (File 682)

UPDATING RESUMED

RELOADED

***Population Demographics -(File 581)

***CLAIMS Citation (Files 220-222)

REMOVED

>>> Enter BEGIN HOMEBASE for Dialog Announcements <<<
>>> of new databases, price changes, etc. <<<

* * * ALL NEW CURRENT YEAR RANGES HAVE BEEN * * *

* * * INSTALLED * * *

SYSTEM:HOME

Cost is in DialUnits

Menu System II: D2 version 1.7.9 term=ASCII

*** DIALOG HOMEBASE(SM) Main Menu ***

Information:

1. Announcements (new files, reloads, etc.)
2. Database, Rates, & Command Descriptions
3. Help in Choosing Databases for Your Topic
4. Customer Services (telephone assistance, training, seminars, etc.)
5. Product Descriptions

Connections:

6. DIALOG(R) Document Delivery
7. Data Star(R)

(c) 2003 Dialog, a Thomson business.

All rights reserved.

/H = Help

/L = Logoff

/NOMENU = Command Mode

Enter an option number to view information or to connect to an online service. Enter a BEGIN command plus a file number to search a database (e.g., B1 for ERIC).

?b 2,6,8,34,434,35,62,65,77,99,144,94,233,238,266,15,16,98,239,275,621,674,256,278,9,14
8,624,553,268,625,474,696

>>> 77 does not exist

>>> 238 does not exist

>>> 278 does not exist

>>>3 of the specified files are not available

07jan04 14:25:22 User264815 Session D40.1

\$0.00 0.153 DialUnits FileHomeBase

\$0.00 Estimated cost FileHomeBase

\$0.46 TELNET

\$0.46 Estimated cost this search

\$0.46 Estimated total session cost 0.153 DialUnits

SYSTEM:OS - DIALOG OneSearch

File 2:INSPEC 1969-2003/Dec W2

(c) 2003 Institution of Electrical Engineers

***File 2: Alert feature enhanced for multiple files, duplicates removal, customized scheduling. See HELP ALERT.**

File 6:NTIS 1964-2004/Jan W1

(c) 2004 NTIS, Intl Cpyrght All Rights Res

File 8:Ei Compendex(R) 1970-2004/Dec W4

(c) 2004 Elsevier Eng. Info. Inc.

File 34:SciSearch(R) Cited Ref Sci 1990-2003/Dec W4

(c) 2003 Inst for Sci Info

***File 34: New prices as of 1/1/2004 per Information Provider request. See HELP RATES 34.**

File 434:SciSearch(R) Cited Ref Sci 1974-1989/Dec

(c) 1998 Inst for Sci Info

***File 434: New prices as of 1/1/2004 per Information Provider request. See HELP RATES434.**

File 35:Dissertation Abs Online 1861-2003/Nov

(c) 2003 ProQuest Info&Learning
File 62:SPIN(R) 1975-2004/Nov W3
(c) 2004 American Institute of Physics
File 65:Inside Conferences 1993-2004/Jan W1
(c) 2004 BLDSC all rts. reserv.
File 99:Wilson Appl. Sci & Tech Abs 1983-2003/Nov
(c) 2003 The HW Wilson Co.
File 144:Pascal 1973-2003/Dec W2
(c) 2003 INIST/CNRS
File 94:JICST-EPlus 1985-2004/Dec W4
(c)2004 Japan Science and Tech Corp(JST)
File 233:Internet & Personal Comp. Abs. 1981-2003/Sep
(c) 2003 EBSCO Pub.
File 266:FEDRIP 2003/Nov
Comp & dist by NTIS, Intl Copyright All Rights Res
File 15:ABI/Inform(R) 1971-2004/Jan 07
(c) 2004 ProQuest Info&Learning
***File 15: Alert feature enhanced for multiple files, duplicate removal, customized scheduling. See HELP ALERT.**
File 16:Gale Group PROMT(R) 1990-2004/Jan 07
(c) 2004 The Gale Group
***File 16: Alert feature enhanced for multiple files, duplicate removal, customized scheduling. See HELP ALERT.**
File 98:General Sci Abs/Full-Text 1984-2003/Nov
(c) 2003 The HW Wilson Co.
File 239:Mathsci 1940-2003/Feb
(c) 2003 American Mathematical Society
File 275:Gale Group Computer DB(TM) 1983-2004/Jan 07
(c) 2004 The Gale Group
File 621:Gale Group New Prod.Annou.(R) 1985-2004/Jan 07
(c) 2004 The Gale Group
File 674:Computer News Fulltext 1989-2003/Dec W3
(c) 2003 IDG Communications
File 256:SoftBase:Reviews,Companies&Prods. 82-2003/Nov
(c)2003 Info.Sources Inc
File 9:Business & Industry(R) Jul/1994-2003/Dec 29
(c) 2003 Resp. DB Svcs.
File 148:Gale Group Trade & Industry DB 1976-2004/Jan 07
(c)2004 The Gale Group
***File 148: Alert feature enhanced for multiple files, duplicate removal, customized scheduling. See HELP ALERT.**
File 624:McGraw-Hill Publications 1985-2004/Jan 07
(c) 2004 McGraw-Hill Co. Inc
***File 624: Homeland Security & Defense and 9 Platt energy journals added**
Please see HELP NEWS624 for more
File 553:Wilson Bus. Abs. FullText 1982-2003/Nov
(c) 2003 The HW Wilson Co
File 268:Banking Info Source 1981-2004/Dec W4
(c) 2004 ProQuest Info&Learning
***File 268: SELECT IMAGE AVAILABILITY FOR PROQUEST FILES**
ENTER 'HELP PROQUEST' FOR MORE
File 625:American Banker Publications 1981-2004/Jan 07
(c) 2004 American Banker
File 474:New York Times Abs 1969-2004/Jan 06
(c) 2004 The New York Times
File 696:DIALOG Telecom. Newsletters 1995-2004/Jan 06
(c) 2004 The Dialog Corp.

Set	Items	Description
---	-----	-----

?s ASIC and (encrypt? or encipher? or cipher?) (s) (password or PIN or identifier or key)

Processed 20 of 29 files ...

Processing

Completed processing all files

92423 ASIC

213615 ENCRYPT?

1220 ENCIPHER?
 14602 CIPHER?
 130042 PASSWORD
 257963 PIN
 39365 IDENTIFIER
 3742227 KEY
 55428 ((ENCRYPT? OR ENCIPHER?) OR CIPHER?) (S) (((PASSWORD OR
 PIN) OR IDENTIFIER) OR KEY)
 S1 439 ASIC AND (ENCRYPT? OR ENCIPHER? OR CIPHER?) (S) (PASSWORD
 OR PIN OR IDENTIFIER OR KEY)
 ?s touchpad or touch (2n) pad or touch (2n) screen
 3909 TOUCHPAD
 458325 TOUCH
 126847 PAD
 4304 TOUCH(2N) PAD
 458325 TOUCH
 974770 SCREEN
 39458 TOUCH(2N) SCREEN
 S2 46785 TOUCHPAD OR TOUCH (2N) PAD OR TOUCH (2N) SCREEN
 ?s COG and ASIC
 9081 COG
 92423 ASIC
 S3 25 COG AND ASIC
 ?s tamper (2n) resistant
 24955 TAMPER
 570334 RESISTANT
 S4 4369 TAMPER (2N) RESISTANT
 ?s keypad or key(1n)pad (s) password? or PIN? or idnetifier? or secret or key?
 >>>File 144 processing for PIN? stopped at PINSKER
 >>>File 16 processing for PIN? stopped at PINPOINTEK
 Processing
 Processed 10 of 29 files ...
 >>>File 148 processing for PIN? stopped at PINOCHET
 Processing
 Processed 20 of 29 files ...
 Completed processing all files
 31925 KEYPAD
 3742227 KEY
 126847 PAD
 163522 PASSWORD?
 23 KEY(1N) PAD(S) PASSWORD?
 1171867 PIN?
 0 IDNETIFIER?
 260196 SECRET
 4420520 KEY?
 S5 5592489 KEYPAD OR KEY(1N) PAD (S) PASSWORD? OR PIN? OR IDNETIFIER?
 OR SECRET OR KEY?
 ?e au= lungaro,james

Ref	Items	Index-term
E1	0	*AU=LUNGARO,JAMES
E2	3	AU=LUNGARONI G
E3	24	AU=LUNGAROTTI F
E4	18	AU=LUNGAROTTI M S
E5	24	AU=LUNGAROTTI MS
E6	9	AU=LUNGAROTTI S
E7	1	AU=LUNGAROTTI, C.
E8	2	AU=LUNGAROTTI, M. S.
E9	2	AU=LUNGAROVA M
E10	1	AU=LUNGAROVA, M.
E11	1	AU=LUNGARZO C
E12	1	AU=LUNGARZO, CARLOS

Enter P or PAGE for more
 ?e au= tso,susan

Ref	Items	Index-term
-----	-------	------------

E1	0	*AU=TSO,SUSAN
E2	5	AU=TSOA E
E3	2	AU=TSOA R
E4	1	AU=TSOA RM
E5	3	AU=TSOA RW
E6	3	AU=TSOA, E.
E7	3	AU=TSOA, EUGENE
E8	1	AU=TSOA, EUGENE YU-SENG
E9	1	AU=TSOANAKIS O
E10	1	AU=TSOAR B
E11	43	AU=TSOAR H
E12	2	AU=TSOAR HAIM

Enter P or PAGE for more
?e au=fernando,llavanya

Ref	Items	Index-term
E1	0	*AU=FERNANDO,LLAVANYA
E2	1	AU=FERNANDOCOELHOESDASILVA J
E3	1	AU=FERNANDODAROCHA L
E4	1	AU=FERNANDODELCIAMPO, L.
E5	1	AU=FERNANDODONGAS MC
E6	1	AU=FERNANDOFUCK G
E7	1	AU=FERNANDOGILDAY C
E8	1	AU=FERNANDOGOTHARDO L
E9	1	AU=FERNANDOMEDRANO J
E10	1	AU=FERNANDOORTEGA C
E11	3	AU=FERNANDOPULE, N.
E12	1	AU=FERNANDOPULIE D

Enter P or PAGE for more
?e au=lee,simon

Ref	Items	Index-term
E1	0	*AU=LEE,SIMON
E2	1	AU=LEE,T.
E3	1	AU=LEE,TIMOTHY
E4	1	AU=LEE,Y. -S.
E5	1	AU=LEE,Y. W.
E6	1	AU=LEE,YUANC
E7	3	AU=LEE,YUNG-CHANG
E8	1	AU=LEE', S.-H.
E9	1	AU=LEEA E J D
E10	1	AU=LEEA HAIWON
E11	1	AU=LEEA HEE-YONG
E12	1	AU=LEEA KYUNG-SUP

Enter P or PAGE for more
?s chip (n) on (n) glass (n) technology
Processing
Processed 10 of 29 files ...
Processing
Processed 20 of 29 files ...
Completed processing all files

898141	CHIP
46634508	ON
1127958	GLASS
9217418	TECHNOLOGY
S6	141 CHIP (N) ON (N) GLASS (N) TECHNOLOGY

?s LCD and s6

136892	LCD
141	S6
S7	98 LCD AND S6

?s7 and ASIC

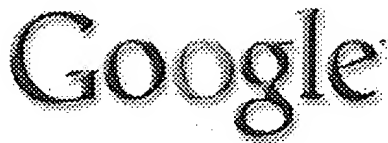
8420585	7
92423	ASIC
S8	12627 7 AND ASIC

?s s7 and ASIC

98 S7

92423 ASIC

S9 2 S7 AND ASIC


[Advanced Search](#)
[Preferences](#)
[Language Tools](#)
[Search Tips](#)

chip on glass technology

Google Search

"on" is a very common word and was not included in your search. [\[details\]](#)

[Web](#) · [Images](#) · [Groups](#) · [Directory](#) · [News](#)

Searched the web for **chip on glass technology**. Results 1 - 10 of about 141,000. Search took 0.33 seconds.

[PDF] **Chip On Glass technology HDG1602P-2**

File Format: PDF/Adobe Acrobat - [View as HTML](#)

... 65.0 10.8 (A /A) 15.7 (V/A) 19. 7 27. 7 15.1 1.8x13=23.4 4.8 5 2.0
2.1 MAX 10.6 1 14 3.15 2.0 **Chip On Glass technology HDG1602P-2**
www.hantronix.com/download/1602p-2.pdf - [Similar pages](#)

[PDF] **Chip On Glass technology HDG12864L-6**

File Format: PDF/Adobe Acrobat - [View as HTML](#)

... g Dimensional Drawing 128 X 64 Dots Graphic, LED Backlight
#Has built-in inverter
for negative power supply Power Supply **Chip On Glass technology**
HDG12864L-6 ...
www.hantronix.com/download/12864l-6.pdf - [Similar pages](#)

[[More results from www.hantronix.com](#)]

[PDF] **Chip On Glass technology HDG12864F-1**

File Format: PDF/Adobe Acrobat - [View as HTML](#)

... inverter for negative power supply Power Supply V DD V 1 V 5 1.0uF x 5
CAP2+ CAP2-
CAP1+ CAP1- VOUT 5.0V + L C M 4.7uF x 3 **Chip On Glass technology**
HDG12864F-1

www.ineltek.ru/pdf/lcd/lcm/Hantronix/graf/12864f1.pdf - [Similar pages](#)

[PDF] **Chip On Glass technology HDG12864F-3**

File Format: PDF/Adobe Acrobat - [View as HTML](#)

... built-in inverter for negative power supply Power Supply V DD V 5 V 1 1.0uF CAP2+
CAP2- CAP1- CAP1+ V OUT 5.0V L C M 2.2uF **Chip On Glass technology HDG12864F-3 ...**
www.ineltek.ru/pdf/lcd/lcm/Hantronix/graf/12864f3.pdf - [Similar pages](#)

[[More results from www.ineltek.ru](#)]

CBC News: Prototype computer chip-on-glass technology displayed

Prototype computer **chip-on-glass technology** displayed Last Updated Tue,

22 Oct 2002 18:05:10 TOKYO - A transparent computer processor ...

cbc.ca/stories/2002/10/22/sharp021022 - 19k - [Cached](#) - [Similar pages](#)

TFT LCDs Employ Chip-On-Glass Technology

Product Locator >> Components & Assemblies >> Displays & Indicators >> LCDs (includes modules, panels, etc.) **TFT LCDs Employ Chip-On-Glass Technology May 1999 ...**

www.eepn.com/Locator/Products/ArticleID/17083/Action/Issue/17083.html - [Similar pages](#)

Character LCD Taps Chip-On-Glass Technology

... Locator >> Components & Assemblies >> Displays & Indicators >> LCDs (includes modules, panels, etc.) **Character LCD Taps Chip-On-Glass Techn I gy November 1999 ...**

www.eepn.com/Locator/Products/ArticleID/18833/Action/Issue/18833.html - [Similar pages](#)

[[More results from www.eepn.com](#)]

New Technology Products - BD-Chip In Glass Displays with Built-in ...

... VFD), which find widespread use as easy-to-see display elements, now face new **technical**

Sponsored Links

Recycled Glass

25 Colors of Recycled Glass
6 sizes from 1/2" down to fine sand

www.americanspecialtyglass.com
Interest: [\[details\]](#)

Custom LCD Display/Module

Medical, Test Equip, Proc Control,
11 Years Experience, 5 Factories

www.lcddesigns.com
Interest: [\[details\]](#)

Mosaic Tile Arts

Mosaic Tiles and Tumbled Glass
Free shipping for orders over \$100

www.mosaictilearts.com
Interest: [\[details\]](#)

[See your message here...](#)

demands for ... has developed the BD series of **chip-in-glass** (CIG) vacuum ...

www.noritake-elec.com/bd_chip_in_glass_built-in.htm - 28k - [Cached](#) - [Similar pages](#)

Computing Canada: Seiko Instruments Vitrium displays use **Chip-On** ...

... Article. Seiko Instruments Vitrium displays use **Chip-On-Glass technology** (the Vitrium G8 liquid-crystal display)(Product Announcement)(Brief Article) Computing ...

www.findarticles.com/cf_dls/m0CGC/n36_v24/21177433/p1/article.jhtml - 11k - [Cached](#) - [Similar pages](#)

Glass Technology Windshield Repair-Gainesville-Florida-1-352-213 ...

Save your Windshield and your money with rock **chip** repair. **Glass Technology** TM Windshield Repair Company Gainesville, Florida. Since 1989. What do we do? ...

rogersunderland.com/glass_technology/windshield_repair.html - 23k - [Cached](#) - [Similar pages](#)

Google

Result Page: [1](#) [2](#) [3](#) [4](#) [5](#) [6](#) [7](#) [8](#) [9](#) [10](#) [Next](#)

chip on glass technology

Google Search

[Search within results](#)

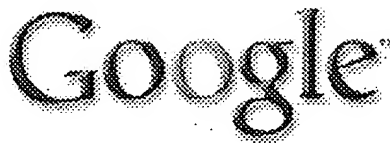
Dissatisfied with your search results? [Help us improve.](#)

Get the [Google Toolbar](#):



[Google Home](#) - [Advertise with Us](#) - [Business Solutions](#) - [Services & Tools](#) - [Jobs, Press, & Help](#)

©2004 Google


[Advanced Search](#) [Preferences](#) [Language Tools](#) [Search Tips](#)

chip on glass technology

Google Search

"on" is a very common word and was not included in your search. [\[details\]](#)

[Web](#) · [Images](#) · [Groups](#) · [Directory](#) · [News](#)

Searched the web for **chip on glass technology**. Results 11 - 20 of about 141,000. Search took 0.21 seconds.

PRESS RELEASE (PRWEB Newswire) SEIKO INTRODUCES DESIGNER'S KIT ...

... to ease the design-in process for engineers using Seiko Instruments' Vitrium™ G4, a ¼ VGA LCD display developed using **Chip-On-Glass technology** for optimal ...
www.prweb.com/releases/1999/7/prweb8576.htm - 27k - [Cached](#) - [Similar pages](#)

PRESS RELEASE (PRWEB Newswire) SEIKO DEBUTS FIRST OFF-THE-SHELF ...

introduces the first off-the-shelf LCD displays developed using **Chip-On-Glass technology** for optimal reliability, contrast and mechanical thinness. ...
www.prweb.com/releases/1998/6/prweb4791.htm - 25k - [Cached](#) - [Similar pages](#)

Sponsored Links

Recycled Glass

25 Colors of Recycled Glass
 6 sizes from 1/2" down to fine sand
www.americanspecialtyglass.com
 interest: ██████████

Custom LCD Display/Module

Medical, Test Equip, Proc Control,
 11 Years Experience, 5 Factories
www.lcddesigns.com
 interest: ██████████

Mosaic Tile Arts

Mosaic Tiles and Tumbled Glass
 Free shipping for orders over \$100
www.mosaictilearts.com
 interest: ██████████

[See your message here...](#)

Design News + Product Design and Development - Chip-On-Glass comes ...

Seiko has introduced what it says are the first off-the-shelf LCD displays developed using **Chip-On-Glass technology**. ...
www.manufacturing.net/dn/article/CA122229 - [Similar pages](#)

Introduction

... support from the Industry & Technology Development Council of the HKSAR Government for the promotion and dissemination of **Chip On Glass Technology** to local ...
www.hkpc.org/hkpc/html/div_coe_unit.asp?service=coe_aeptc&unit=4 - 4k - [Cached](#) - [Similar pages](#)

Tianma Microelectronics Chip-On-Glass (COG)

... Since the **Chip-On-Glass** integrated circuit has been invented by Epson, COG technology became very popular due to the demand for more compact applications. ...
www.tianma.com/technologies/cog.htm - 18k - [Cached](#) - [Similar pages](#)

Noritake's Automation Excellence Award 2of3

... Advances in **Chip-in-Glass technology** provide VFD graphics modules increased function, lower cost and a more compact design. Fig 1. Structural Schema of BD VFD. ...
www.noritake-elec.com/award2.htm - 7k - [Cached](#) - [Similar pages](#)
[\[More results from www.noritake-elec.com \]](#)

ECN - Customized Chip on Glass LCD Modules

... functionality. Data Modul's advanced COG technology (**Chip on Glass**) is particularly effective when designing custom-made modules. It ...
www.reedelectronicsgroup.com/esec/Article_212626.htm - [Similar pages](#)

nextek inc. manufacturing services for advanced technology, high ...

... 6 axis alignment, active alignment, advanced **technol gy**, alumina, analytical ... package, ceramic, **chip on board**, **chip on flex**, **chip on glass**, **chip scale package** ...

www.nextekinc.com/careerZ.html - 9k - [Cached](#) - [Similar pages](#)

[nextek inc. manufacturing services for advanced technology, high ...](#)
6 axis alignment, active alignment, advanced **technology**, alumina, analytical
laboratory ... **chip** on board, **chip** on flex, **chip** on **glass**, **chip** scale package ...
www.nextekinc.com/servicesZ.html - 8k - [Cached](#) - [Similar pages](#)
[[More results from www.nextekinc.com](#)]

Technology Review: Chips Go 3-D

... Mike Farmwald, cofounder of **chip** connection **technology** company Rambus, and others—starts with a standard silicon **chip**. It paves the **chip** with **glass**, adds a ...
www.techreview.com/articles/innovation40102.asp - [Similar pages](#)

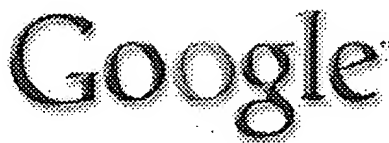


Result Page: [Previous](#) [1](#) [2](#) [3](#) [4](#) [5](#) [6](#) [7](#) [8](#) [9](#) [10](#) [11](#) [Next](#)

[Search within results](#)

[Google Home](#) - [Advertise with Us](#) - [Business Solutions](#) - [Services & Tools](#) - [Jobs, Press, & Help](#)

©2004 Google


[Advanced Search](#) [Preferences](#) [Language Tools](#) [Search Tips](#)

chip on glass technology and ASI

Google Search

"on" is a very common word and was not included in your search. [\[details\]](#)

The "AND" operator is unnecessary -- we include all search terms by default. [\[details\]](#)

[Web](#) · [Images](#) · [Groups](#) · [Directory](#) · [News](#)

Searched the web for **chip on glass technology and ASIC**. Results **1 - 10** of about **4,450**. Search took **0.16** sec

PRESS RELEASE (PRWEB Newswire) SEIKO DEBUTS FIRST OFF-THE-SHELF ...

... **Chip-On-Glass technology** eliminates the use of zebra ... for standard quad flat pack **chips** or drivers ... Galaxy QuickForm Pulse Charge/Termination **technology** shows 30 ...

www.prweb.com/releases/1998/6/prweb4791.htm - 25k - [Cached](#) - [Similar pages](#)

[PDF] High-Sensitivity Smart Sensors Based on Thin-Film on ASIC ...

File Format: PDF/Adobe Acrobat

... CSEM, high-efficiency APS in TFA **technology** are currently ... been deposited on chromium-coated **glass** sub- strates ... far been carried out on a **chip** (BIOCHIP) designed ...

www.csem.ch/corporate/Report2002/pdf/p42.pdf - [Similar pages](#)

New Technology Products - CL-Active Matrix Displays

... matrixes are fabricated and arranged on the **glass** plate ... This **technology** reduces the number of lead wires pulled ... diagram of the inside of a **chip**.) The interface ...

www.noritake-elec.com/cl_active_matrix_displays.htm - 33k - [Cached](#) - [Similar pages](#)

[PDF] ASIC Packaging

File Format: PDF/Adobe Acrobat - [View as HTML](#)

... Inside its Flip-**chip** BGA packages, Fujitsu's unique wiring strip interconnect ... Key features of Fujitsu's FC-BGA **technology** are: • **Glass** Ceramics or ...

www.fma.fujitsu.com/pdf/ASIC%20PKG.pdf - [Similar pages](#)

JAPAN IMC/IEMT April 1998 HighLights

... CSP. The 64M DRAM **chip** was connected to the **glass** ceramic substrate via Au bumps by flip **chip** bonding **technique**. "Reliability ...

www.ewh.ieee.org/soc/cpmt/newsletter/199806/JaplMCF.html - 9k - [Cached](#) - [Similar pages](#)

Appendix 1-B - Canadian Industry Sector Technology Interests

... example, flip-**chip**, **chip-on-glass**, **chip-on-board** ... **chip**, board and product design services for telecommunication ... RF, digital and mixed-signal **technology** for radar ...

www.cmc.ca/about/corporation/plan/Module1/appendix1b.html - 6k - [Cached](#) - [Similar pages](#)

Resources

... It is covered with epoxy. Top. **Chip-on-Glass** (COG) is a new **techn** **logy** that mounts the LCD driver to the contact edge of the LCD **glass**. Top. ...

www.amulettechnologies.com/glossary.html - 27k - [Cached](#) - [Similar pages](#)

Skyline Sales & Associates, Inc.

... EDT has a full range of LCD products that features STN and FSTN **technology** with

Sponsored Links

Recycled Glass

25 Colors of Recycled Glass
6 sizes from 1/2" down to fine sand
www.americanspecialtyglass.com
Interest: [Interest](#)

Custom LCD Display/Module

Medical, Test Equip, Proc Control,
11 Years Experience, 6 Factories
www.lcddesigns.com
Interest: [Interest](#)

Mosaic Tile Arts

Mosaic Tiles and Tumbled Glass
Free shipping for orders over \$100
www.mosaictilearts.com
Interest: [Interest](#)

[See your message here...](#)

COB (**chip** on board) COF (**chip** on flex), COG (**chip** on **glass**), TAB (tape ...
www.skylinesalesassoc.com/skyline_lines.html - 19k - [Cached](#) - [Similar pages](#)

Electronic News: Amkor Gains LSI Logic Know-How.(Amkor **Technology** ...
 ... to make its organic laminate flip **chip technology** an industry ... for various system-on-a-chip
 and other designs, competing against **glass** ceramic materials ...
www.findarticles.com/cf_dls/m0EKF/2249_44/53510616/p1/article.jhtml - 13k - [Cached](#) - [Similar pages](#)

EM Microelectronic, low power ICs, RFID, microcontroller, ultra ...
 ... Assembly **technologies** - COB, **Chip-on-Board technology** - COG, **Chip-on-Glass technology**
 - COF, **Chip-on-Film technology** - With integrated back-light or front ...
www.emmarin.com/Line.asp?IdLine=30 - 29k - [Cached](#) - [Similar pages](#)

Goooooooooooooogle ►

Result Page: 1 2 3 4 5 6 7 8 9 10 [Next](#)

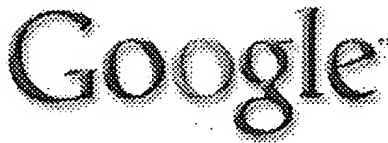
[Search within results](#)

Dissatisfied with your search results? [Help us improve.](#)

Get the [Google Toolbar](#):

[Google Home](#) - [Advertise with Us](#) - [Business Solutions](#) - [Services & Tools](#) - [Jobs, Press, & Help](#)

©2004 Google


[Advanced Search](#) [Preferences](#) [Language Tools](#) [Search Tips](#)

chip on glass technology and AS

Google Search

"on" is a very common word and was not included in your search. [\[details\]](#)
 The "AND" operator is unnecessary -- we include all search terms by default.
[\[details\]](#)

[Web](#) · [Images](#) · [Groups](#) · [Directory](#) · [News](#)
Searched the web for **chip on glass technology and ASIC and LCD**. Results 1 - 10 of about 1,200. Search took

EM Microelectronic, low power ICs, RFID, microcontroller, ultra ...

... using a variety of different **LCD** and assembly **technologies**. Assembly **technologies**

- COB, **Chip-on-Board technology** - COG, **Chip-on-Glass technology** - COF, **Chip-on ...**

www.emmarin.com/Line.asp?IdLine=30 - 29k - [Cached](#) - [Similar pages](#)

EM Microelectronic, low power ICs, RFID, microcontroller, ultra ...

... EM's **LCD** drivers ICs often require no external component and can be used

with **Chip-On-Glass**, **Chip-on-Flex**, **Chip on Board** or **TAB technologies**. ...

www.emmarin.com/Line.asp?IdLine=6 - 34k - [Cached](#) - [Similar pages](#)

[[More results from www.emmarin.com](#)]

Sponsored Links

Recycled Glass

25 Colors of Recycled Glass
 6 sizes from 1/2" down to fine sand
www.americanspecialtyglass.com
 interest: ██████████

Custom LCD Display/Module

Medical, Test Equip, Proc Control,
 11 Years Experience, 8 Factories
www.lcddesigns.com
 interest: ██████████

Mosaic Tile Arts

Mosaic Tiles and Tumbled Glass
 Free shipping for orders over \$100
www.mosaictilearts.com
 interest: ██████████

PRESS RELEASE (PRWEB Newswire) SEIKO DEBUTS FIRST OFF-THE-SHELF ...

... **Chip-On-Glass technology** eliminates the use of zebra ... for standard quad flat pack chips or drivers ... Galaxy QuickForm Pulse Charge/Termination **technology** shows 30 ...

www.prweb.com/releases/1998/6/prweb4791.htm - 25k - [Cached](#) - [Similar pages](#)

[See your message here...](#)

Resources

... It is covered with epoxy. Top. **Chip-on-Glass (COG)** is a new **technology** that mounts the **LCD** driver to the contact edge of the **LCD glass**. Top. ...

www.amulettechnologies.com/glossary.html - 27k - [Cached](#) - [Similar pages](#)

UV Cured Adhesives, LEDs, LCD Displays, PCB Design, Crystals ...

... Modular Kit Enclosed Shaft Employing phased-array **ASIC technology** Resolutions up to ... Type **TAB** (Tape Automated Bonding) & **COG** (**Chip on Glass** Character Type) ...

www.prorepc.com/ - 19k - [Cached](#) - [Similar pages](#)

logic1sales2

... Design and manufacture a broad selection of **LCD** and **LCM technologies** including "chip on glass" and "chip on film" to meet customer ...

Description: Manufacturers' representative of optical network and connectivity, synchronisation and timing products,...

Category: [Business > Electronics and Electrical > ...](#)

www.logic1sales.com/ - 19k - [Cached](#) - [Similar pages](#)

碧悠電子工業股份有限公司

... **TAB bonding techn logy** can be widely use on different application such as (1) Soft mechanical device : **LCD** Module ... A: **COG** stand for **Chip-on-Glass**, it use **ACF** ...

portal-ap.picvue.com.tw/picvue/english/FAQ.htm - 36k - [Cached](#) - [Similar pages](#)

SMaL Technology

... Kit uses SMaL's proprietary Autobrite wide dynamic range **technology** which adapts ... Timing and Control, **On-chip**. ... Lens, 4-element **glass**, focal length = 7 mm, F/3.2 ...

www.smalcamera.com/up3lcd.html - 14k - [Cached](#) - [Similar pages](#)

Yahoo! Directory Semiconductor Makers

... in the form of compact hybrid **glass** circuits on ... supplier of custom communication **chips** for the ... Sitronix **Technology** Corporation [SPONSOR] - design house for **LCD** ...

dir.yahoo.com/.../Business_to_Business/Electronics/Board_Level_Components/Semiconductors/Makers/ - 32k - [Cached](#) - [Similar pages](#)

Elatec - EM Marin

... Voltage bias and mux signal generated on **chip**; 8 x 60 ... industry standard of 2 x 1.1mm **glass**, which is ... analog designs with Mixed Mode Array **technology** for medium ...

www.elateceurope.com/emmarin/ - 30k - [Cached](#) - [Similar pages](#)

Google

Result Page: 1 2 3 4 5 6 7 8 9 10 [Next](#)

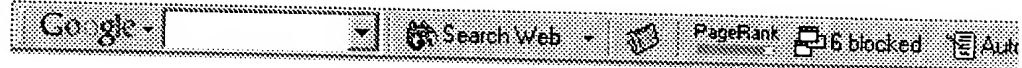
chip on glass technology and ASI

Google Search

[Search within results](#)

Dissatisfied with your search results? [Help us improve.](#)

Get the [Google Toolbar](#):



[Google Home](#) - [Advertise with Us](#) - [Business Solutions](#) - [Services & Tools](#) - [Jobs, Press, & Help](#)

©2004 Google